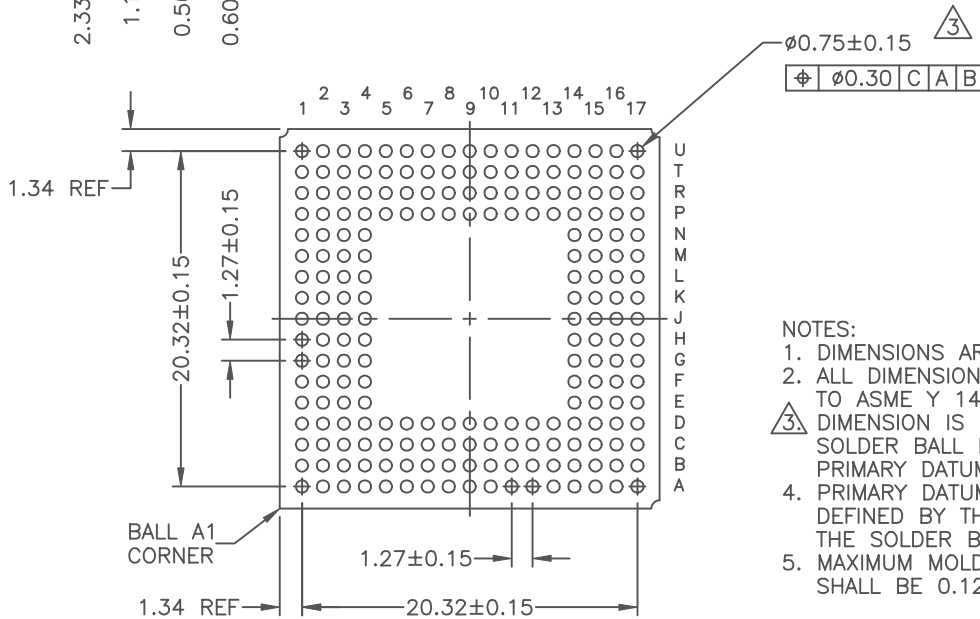
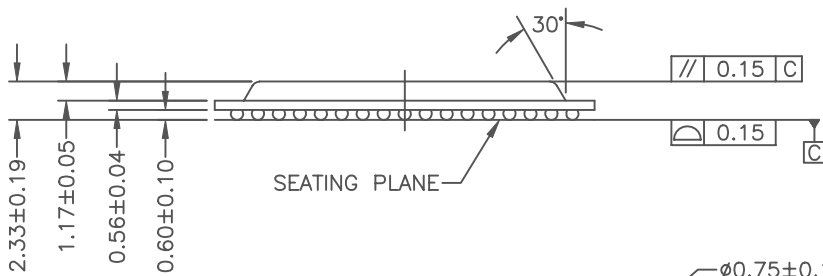
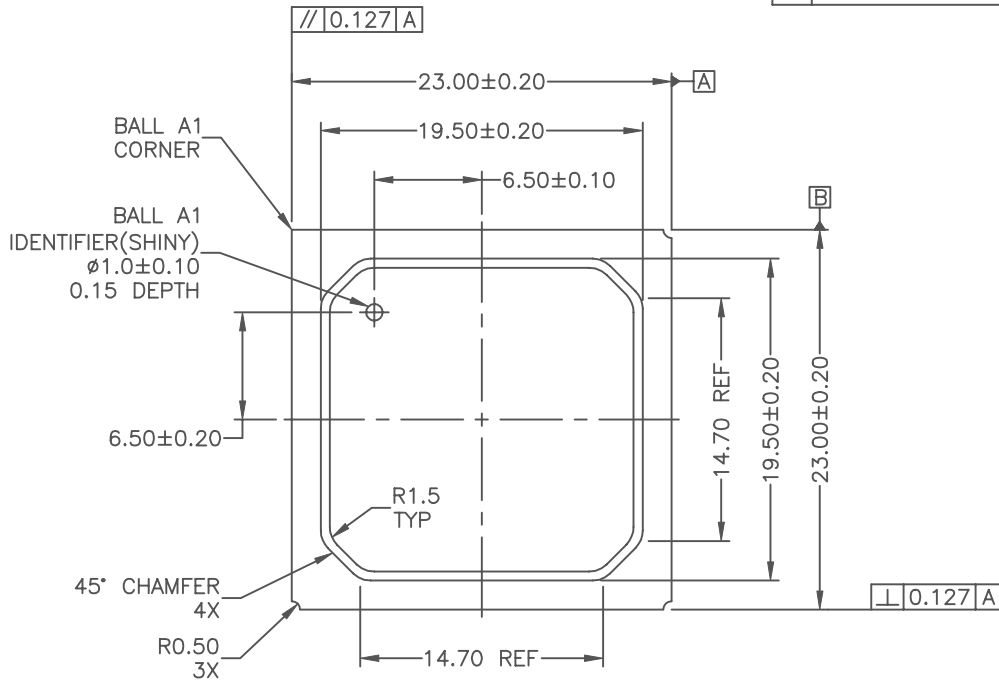


| REVISIONS |             |      |          |
|-----------|-------------|------|----------|
| LTR       | DESCRIPTION | DATE | APPROVED |
| A         | NEW DRAWING |      |          |



- NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
  2. ALL DIMENSIONS AND TOLERANCE CONFORM TO ASME Y 14.5M-1994.
  3. DIMENSION IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C
  4. PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
  5. MAXIMUM MOLD TO SUBSTRATE OFFSET SHALL BE 0.127.

|                            |  |      |  |   |  |         |  |              |  |     |  |
|----------------------------|--|------|--|---|--|---------|--|--------------|--|-----|--|
| SIGNATURE                  |  | DATE |  |   |  |         |  |              |  |     |  |
| DOC. CONTROL:              |  |      |  |   |  |         |  |              |  |     |  |
| ENGR. MGR: M. Strittmatter |  | 1/98 |  | TITLE<br>MARKETING OUTLINE - 208 PBGA<br>23 X 23, 2.33 THICK, 4 LAYER |  |         |  |              |  |     |  |
| MFG. ENGR: B. McCarty      |  | 1/98 |  |   |  |         |  |              |  |     |  |
| CHECKED BY: R. Khan        |  | 1/98 |  | SIZE  |  | FSCM NO |  | PART NO.     |  | REV |  |
| DRAWN BY: R. Erbacher      |  | 1/98 |  | A   |  |         |  | 56-G6001-001 |  | A   |  |
| DO NOT SCALE DWG.          |  |      |  | SCALE 2/1   |  |         |  | SHEET 1 OF 1 |  |     |  |